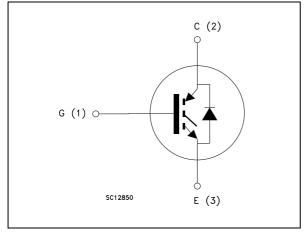


STGW60V60F

Trench gate field-stop IGBT, V series 600 V, 60 A very high speed

TO-247

Figure 1. Internal schematic diagram



Datasheet - production data

Features

- Maximum junction temperature: T_J = 175 °C
- Tail-less switching off •
- V_{CE(sat)} = 1.85 V (typ.) @ I_C = 60 A
- Tight parameters distribution
- Safe paralleling •
- Low thermal resistance
- Lead free package

Applications

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- Very high frequency converters

Description

This device is an IGBT developed using an advanced proprietary trench gate field stop structure. The device is part of the V series of IGBTs, which represent an optimum compromise between conduction and switching losses to maximize the efficiency of very high frequency converters. Furthermore, a positive V_{CE(sat)} temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW60V60F	GW60V60F	TO-247	Tube

This is information on a product in full production.

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600	V
۱ _C	Continuous collector current at T _C = 25 °C	80 ⁽¹⁾	А
۱ _C	Continuous collector current at T _C = 100 °C	60	А
$I_{CP}^{(2)}$	Pulsed collector current	240	А
V_{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$	375	W
T _{STG}	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature	- 55 to 175	°C

Table 2. Absolute maximum ratings

1. Current level is limited by bond wires

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case IGBT	0.4	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W



2 Electrical characteristics

 $T_J = 25$ °C unless otherwise specified.

Table 4. Static characteristics						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 2 mA	600			V
V _{CE(sat)} Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 60 \text{ A}$		1.85	2.3		
		V _{GE} = 15 V, I _C = 60 A T _J = 125 °C		2.15		v
		V _{GE} = 15 V, I _C = 60 A T _J = 175 °C		2.35		
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	5.0	6.0	7.0	V
I _{CES}	Collector cut-off current $(V_{GE} = 0)$	V _{CE} = 600 V			25	μA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			250	nA

Table 4. Static characteristics	Table 4.	Static	characteristics
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Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance		-	8000	-	pF
C _{oes}	Output capacitance	V _{CE} = 25 V, f = 1 MHz,	-	280	-	pF
C _{res}	Reverse transfer capacitance	V _{GE} = 0	-	170	-	pF
Qg	Total gate charge		-	334	-	nC
Q _{ge}	Gate-emitter charge	V _{CC} = 480 V, I _C = 60 A, V _{GE} = 15 V, see <i>Figure</i> 23	-	130	-	nC
Q _{gc}	Gate-collector charge		-	58	-	nC



Symbol	Parameter	Test conditions	Min.	, Тур.	Max.	Unit
t _{d(on)} ⁽¹⁾	Turn-on delay time		-	60	-	ns
t _r ⁽¹⁾	Current rise time		-	20	-	ns
(di/dt) _{on} ⁽¹⁾	Turn-on current slope	-	-	2365	-	A/μs
t _{d(off)}	Turn-off delay time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	208	-	ns
t _f	Current fall time	$R_G = 4.7 \Omega$, V _{GE} = 15 V, see <i>Figure</i> 22	-	14	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses		-	0.75	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	0.55	-	mJ
E _{ts}	Total switching losses		-	1.3	-	mJ
t _{d(on)} ⁽¹⁾	Turn-on delay time		-	57	-	ns
t _r ⁽¹⁾	Current rise time		-	23	-	ns
(di/dt) _{on} ⁽¹⁾	Turn-on current slope	V _{CF} = 400 V, I _C = 60 A <i>,</i>	-	2191	-	A/μs
t _{d(off)}	Turn-off delay time	$R_{G} = 4.7 \Omega, V_{GE} = 15 V,$	-	216	-	ns
t _f	Current fall time	T _J = 175 °C, see	-	27	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses	Figure 22	-	1.5	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	0.8	-	mJ
E _{ts}	Total switching losses		-	2.3	-	mJ

Table 6. IGBT switching characteristics (inductive load)

1. Switching-on times and energy have been calculated applying the STGW60V60DF's co-pack diode in the high side of the test circuit in Figure 22. Both IGBT and diode are at the same temperature. Energy losses include reverse recovery of the diode.

2. Turn-off losses include also the tail of the collector current.



2.1 Electrical characteristics (curves)

Figure 2. Power dissipation vs. case temperature

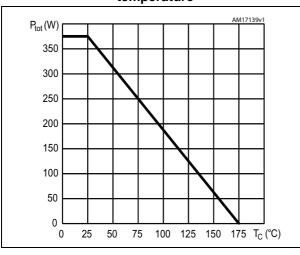


Figure 4. Output characteristics @ 25 °C

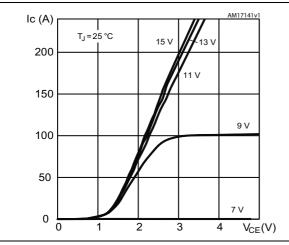
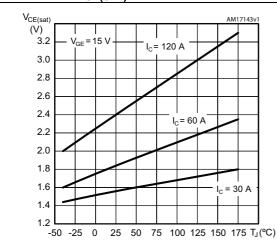


Figure 6. V_{CE(SAT)} vs. junction temperature





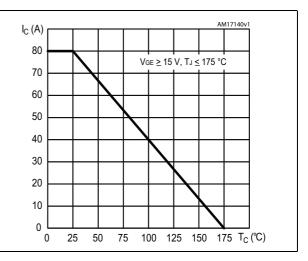


Figure 5. Output characteristics @ 175 °C

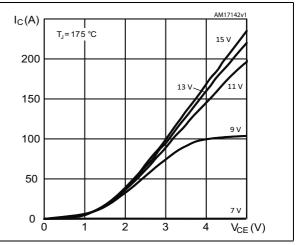


Figure 7. V_{CE(SAT)} vs. collector current

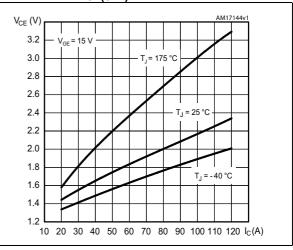




Figure 8. Collector current vs. switching frequency

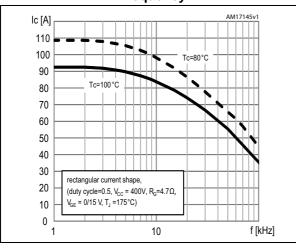


Figure 10. Normalized V_{GE(th)} vs. junction temperature

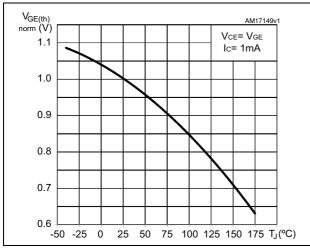


Figure 12. Capacitance variations



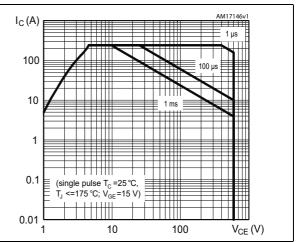
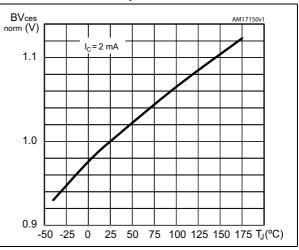
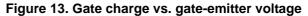


Figure 11. Normalized BV_{CES} vs. junction temperature





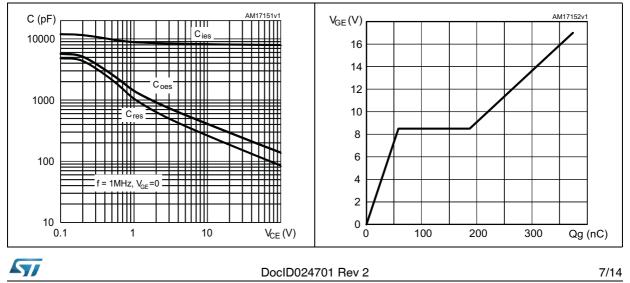


Figure 14. Switching losses vs. collector current

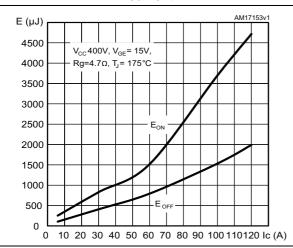


Figure 16. Switching losses vs. junction temperature

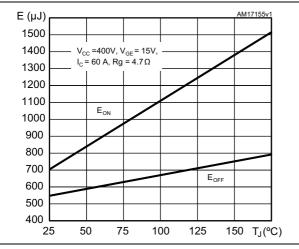
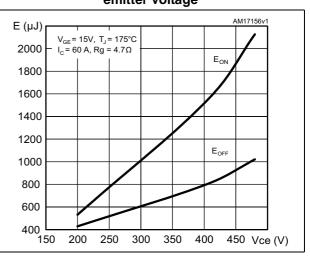
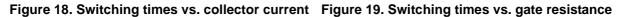


Figure 17. Switching losses vs. collector emitter voltage





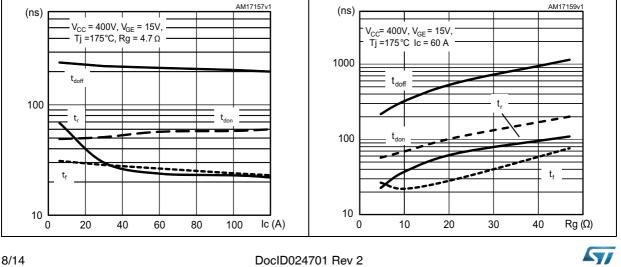
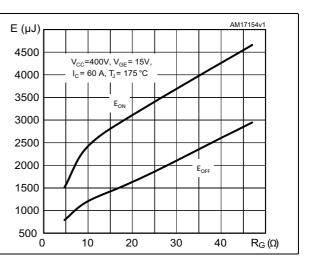
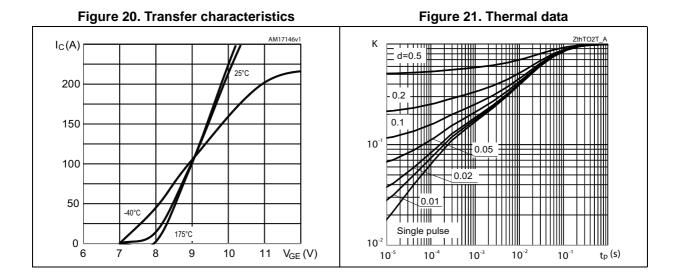


Figure 15. Switching losses vs. gate resistance





Test circuits 3

Figure 22. Test circuit for inductive load switching ____V cc ο A ۰A С 12V 47ΚΩ L=100µH 1KΩ G =100nF 3.3 1000 ုB μ F μ F $V_{\rm CC}$ I_G=CONST c $V_i = 20V = V_{GMAX}$ 1KΩ С.U.Т. G | 👗 D.U.T. \sim 2200 #F V G --0 2.7KΩ Ε R_{G} ø 47K Ω 1KΩ Pw AM01504v1 AM01505v1

Figure 24. Switching waveform

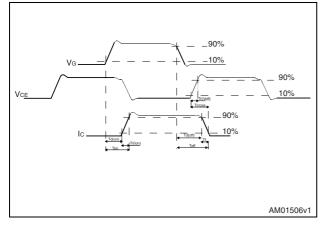


Figure 23. Gate charge test circuit

Package mechanical data 4

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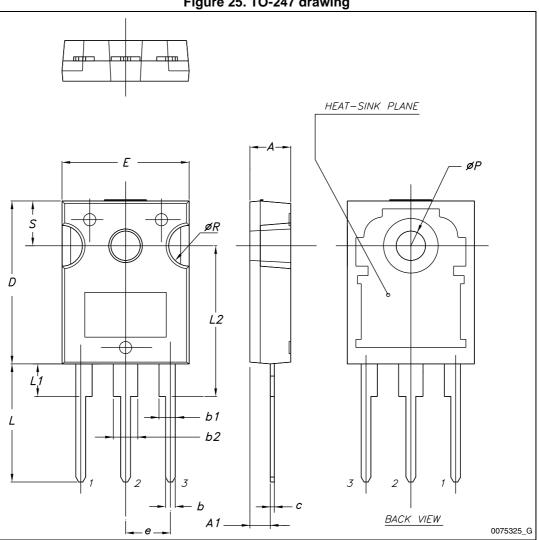


Figure 25. TO-247 drawing



		mm.	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0 3		3.40
с	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Table 7. TO-247 mechanical data



5 Revision history

06-Feb-2014

2

Date	Revision	Changes		
04-Jun-2013	1	Initial release.		
		Updated Figure 1: Internal schematic diagram.		

Minor text changes.

Updated title, features and description in cover page.

Table 8. Document revision history



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